

NCE N-Channel Super Trench Power MOSFET

Description

The NCEP3065BQU uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

General Features

V_{DS} =30V,I_D =65A

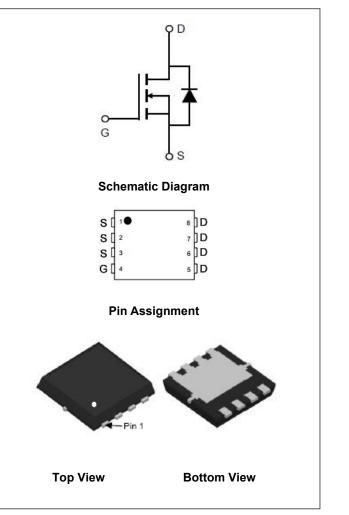
 $R_{DS(ON)}$ =1.75mΩ (typical) @ V_{GS}=10V $R_{DS(ON)}$ =2.0mΩ (typical) @ V_{GS}=4.5V $R_{DS(ON)}$ =2.6mΩ (typical) @ V_{GS}=2.5V

- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 150 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

100% UIS TESTED! 100% ΔVds TESTED!



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP3065BQU	NCEP3065BQU	DFN3.3X3.3-8L	-	-	-

Absolute Maximum Ratings (T_c=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	VDS	30	V	
Gate-Source Voltage	Vgs	±12	V	
Drain Current-Continuous	I _D	65	А	
Drain Current-Continuous(Tc=100 ℃)	I _D (100℃)	45.5	А	
Pulsed Drain Current ^(Note 1)	I _{DM}	260	А	
Maximum Power Dissipation	PD	55	W	
Derating factor		0.44	W/℃	
Single pulse avalanche energy (Note 5)	E _{AS}	260	mJ	
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 150	°C	
Thermal Characteristic				
Thermal Resistance, Junction-to-Case ^(Note 2)	Rejc	2.3	°C/W	



Electrical Characteristics (Tc=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Мах	Unit
Off Characteristics	-					1
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	30		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±12V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	-					
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	0.45	-	1.0	V
	R _{DS(ON)}	V _{GS} =10V, I _D =20A	-	1.75	1.95	mΩ
Drain-Source On-State Resistance		V _{GS} =4.5V, I _D =20A	-	2.0	2.3	mΩ
		V _{GS} =2.5V, I _D =20A	-	2.6	3.1	mΩ
Forward Transconductance	g fs	V _{DS} =5V,I _D =20A		60	-	S
Dynamic Characteristics (Note4)						1
Input Capacitance	Clss	V _{DS} =15V,V _{GS} =0V,	-	3115	-	PF
Output Capacitance	Coss		-	928	-	PF
Reverse Transfer Capacitance	Crss	F=1.0MHz	-	37	-	PF
Switching Characteristics (Note 4)			·			
Turn-on Delay Time	t _{d(on)}		-	10	-	nS
Turn-on Rise Time	tr	V _{DD} =15V,I _D =20A	-	5	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =10V,R _G =1.6Ω	-	45	-	nS
Turn-Off Fall Time	t _f		-	9.5	-	nS
Total Gate Charge	Qg)/ 45)// 00A	-	30.4	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =15V,I _D =20A,	-	3.1		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =4.5V	-	5.1		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =20A	-		1.2	V
Diode Forward Current (Note 2)	ls		-	-	65	Α
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F = I _S	-	18	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	26	-	nC
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Notes:

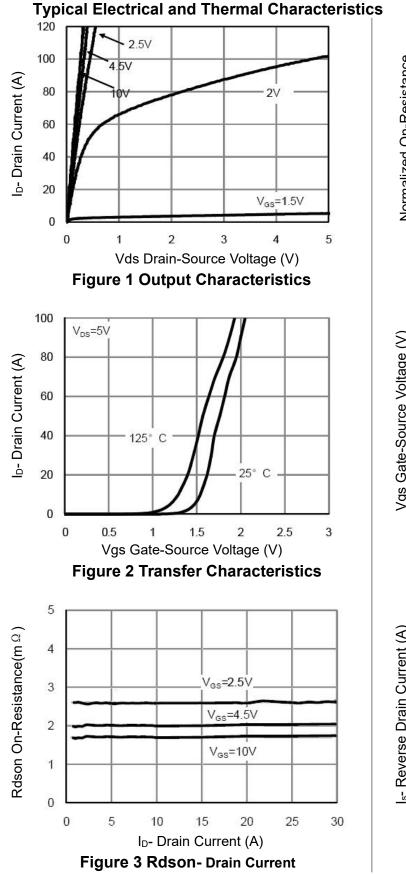
1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, t \leq 10 sec.

3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.

4. Guaranteed by design, not subject to production 5. EAS condition : Tj=25 $^\circ\!\!C,V_{DD}$ =15V,V_G=10V,L=0.5mH,Rg=25 Ω





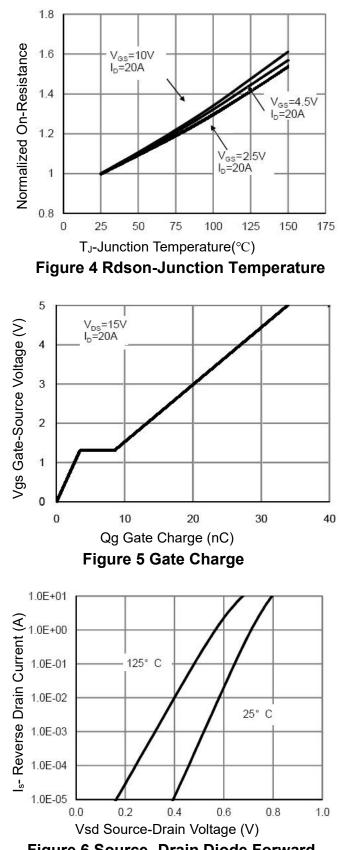


Figure 6 Source- Drain Diode Forward



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NCEP3065BQU

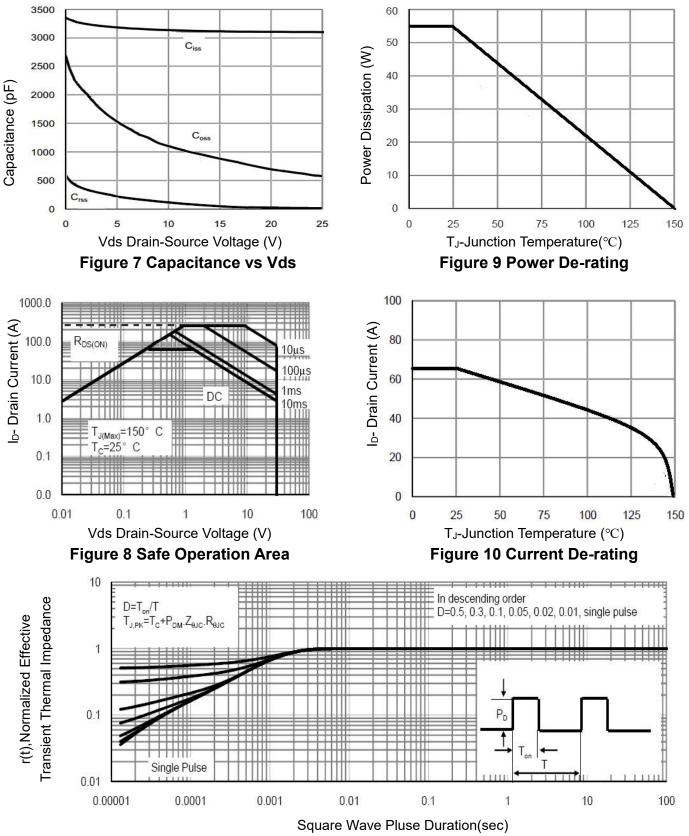
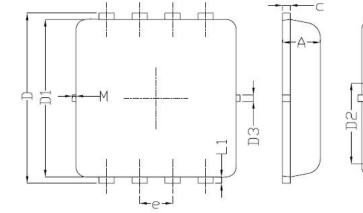
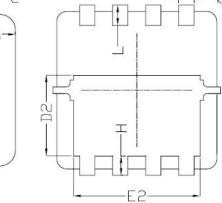


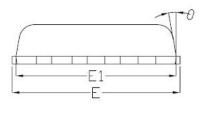
Figure 11 Normalized Maximum Transient Thermal Impedance

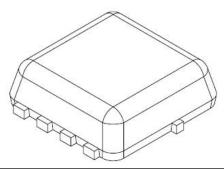


DFN3.3X3.3-8L Package Information









Cumhal	Dimensions In Millimeters				
Symbol	Min.	Nom.	Max.		
A	0.70	0.75	0.80		
b	0.25	0.30	0.35		
с	0.10	0.15	0.25		
D	3.25	3.35	3.45		
D1	3.00	3.10	3.20		
D2	1.78	1.88	1.98		
D3	-	0.13	-		
E	3.10	3.20	3.30		
E1	3.00	3.15	3.20		
E2	2.39	2.49	2.59		
е	0.65BSC				
Н	0.30	0.39	0.50		
L	0.30	0.40	0.50		
L1	-	0.13	-		
М	* *		0.15		
θ		10 [°]	12 [°]		



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